#### Absolute Maximum Ratings (Ta = 25°C)

	Characteristics	Symbol	Rating	Unit
LED	Forward current	lF	50	mA
	Forward current derating (Ta $\ge$ 25°C)	ΔI <sub>F</sub> /°C	-0.5	mA/°C
	Pulse forward current (100 µs pulse, 100 pps)	IFP	1	А
	Reverse voltage	VR	5	V
	Diode power dissipation	PD	50	mW
	Diode power dissipation derating (Ta $\geq$ 25°C)	$\Delta P_D / C$	-0.5	mW/°C
	Junction temperature	Tj	125	°C
	Off-state output terminal voltage	Voff	200	V
	On-state current	ION	200	mA
Detector	On-state RMS current derating (Ta $\ge$ 25°C)	Δlon/°C	-2.0	mA/°C
Delector	Output power dissipation	Po	180	mW
	Output power dissipation derating (Ta $\ge$ 25°C)	ΔP <sub>O</sub> /°C	-1.8	mW / °C
	Junction temperature	Tj	125	°C
Storage ter	mperature range	T <sub>stg</sub>	-55 to 125	°C
Operating	temperature range	Topr	-40 to 85	°C
Lead solde	ring temperature (10 s)	T <sub>sol</sub>	260	°C
Isolation vo	bltage (AC, 60 s, R.H. ≤ 60 %) (Note1)	BVs	1500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note1: Device considered a two-terminal device: pins1 and 2 shorted together and pins 3 and 4 shorted together.

#### **Recommended Operating Conditions**

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	V <sub>DD</sub>		150	200	V
Forward current	lF	5	7.5	25	mA
On-state current	ION	_	_	130	mA
Operating temperature	T <sub>opr</sub>	-20	_	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

#### **Individual Electrical Characteristics (Ta = 25°C)**

	Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
LED	Forward voltage	VF	$I_F = 10 \text{ mA}$	1.0	1.15	1.3	V
	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 5 V	_	_	10	μA
	Capacitance between terminals	Ст	VF = 0 V, f = 1 MHz	_	30	—	pF
Detector	Off-state current	IOFF	$V_{OFF} = 200 V$	_	_	1	μA
	Capacitance between terminals	COFF	V = 0 V, $f = 1 MHz$	_	100	—	pF

### **Coupled Electrical Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	lft	$I_{ON} = 200 \text{ mA}$		1	3	mA
On-state resistance	Ron	$I_{ON} = 200 \text{ mA}, I_F = 5 \text{ mA}$		5	8	Ω
Return LED current	IFC	$IOFF = 100 \ \mu A$	0.1		_	mA

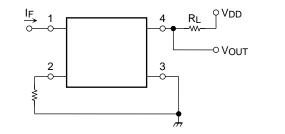
#### **Isolation Characteristics (Ta = 25°C)**

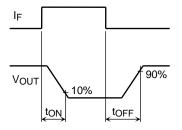
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	Cs	$V_S = 0 V$ , f = 1 MHz	_	0.8	_	pF
Isolation resistance	Rs	$V_S=500$ V, R.H. $\leq 60$ %	$5\times 10^{10}$	10 <sup>14</sup>	_	Ω
Isolation voltage	BVs	AC, 60 s	1500		_	Vrms

#### Switching Characteristics (Ta = 25°C)

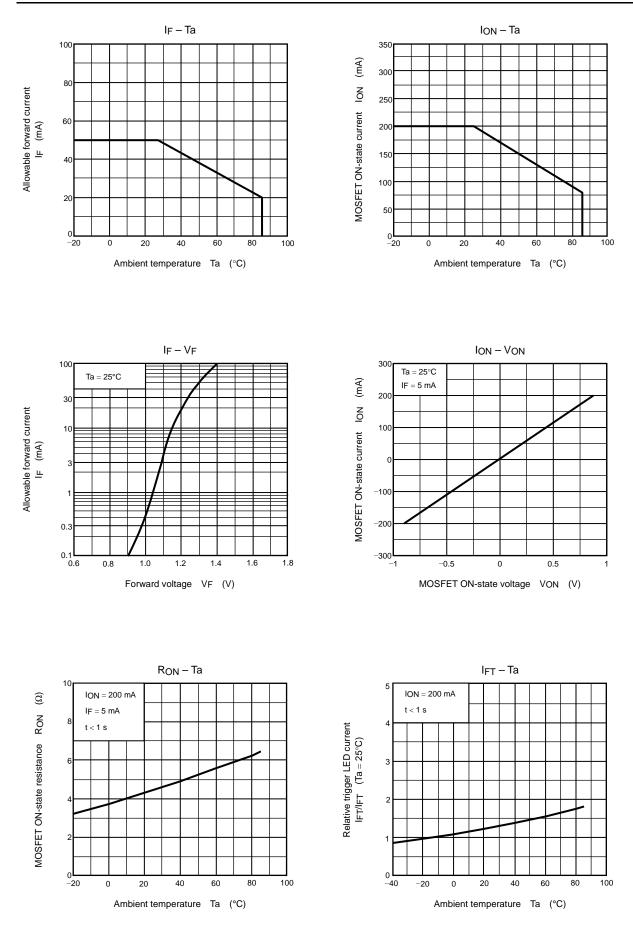
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	tON		_	0.6	1.5	ms
Turn-off time	tOFF		_	0.1	1.0	ms

Note: Switching time test circuit



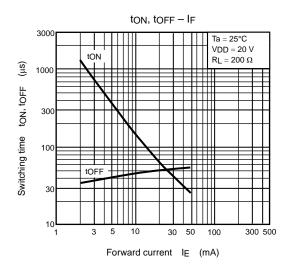


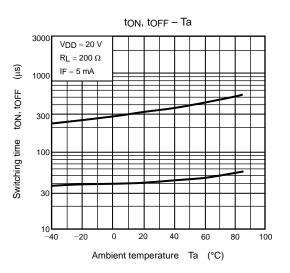
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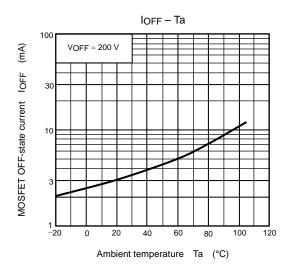


NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

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NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

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